MDI for 4x25G Copper and Fiber Optic IO

Quadra (CFP4 proposal) Connector System

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4x25Gb/s MDI Potential Requirements Critical Needs:

- Excellent electrical performance for both copper and fiber applications
 - Low insertion loss, low crosstalk, and good return loss
- Optimized for ability to manage thermal dissipation
- Supports direct attach copper cable assemblies, passive and active
- Supports SR, LR transceivers and active optical cables
- Integrated EMI management
- Achieves high density





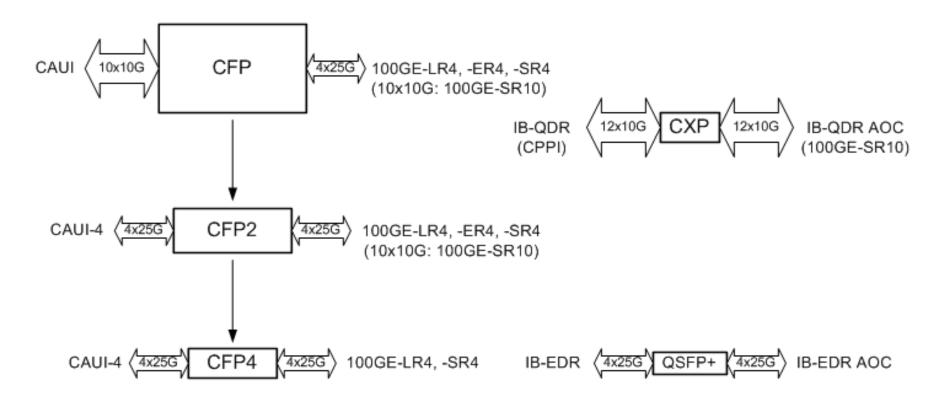
MDI Options

- QSFP25 as presented in palkert_01a_0911.pdf provides backwards compatibility
- CFP MSA is developing CFP2 and CFP4 Optics for 4x25G applications
 - Offers a multi-generational approach to allow for technology cycles
 - Provides for increased range of power dissipation
 - Designed to support lower density long reach and higher density short reach
 - Uses a common electrical interface for CFP2 and CFP4
 - Cage design incorporates comprehensive EMI containment features





CFP MSA Roadmap



Module shapes all drawn approximately to same scale

Roadmap supplied courtesy of the CFP MSA





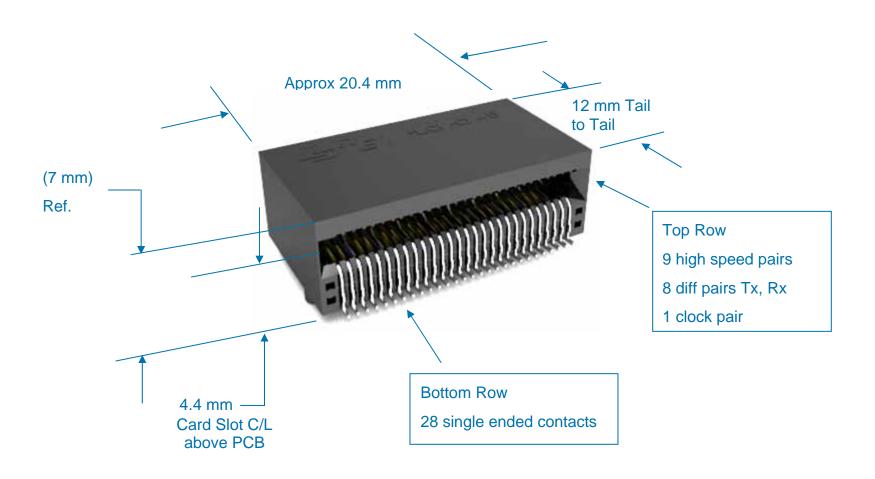
Quadra Connector Overview

- Designed specifically for optimized performance up to 28Gb/s
- Two piece plug and receptacle system allows tighter mating tolerance to be held which optimizes electrical performance
- All high speed pairs are located on the top row of the connector, eliminating vias on the transceiver PCB
- Optimized layout and routing of host and module PCB to enhance channel performance
- Same electrical performance for CFP2 and CFP4, just different pin count
- Surface mount design accommodates belly to belly high density applications





Quadra Connector (CFP4 Proposal), Receptacle

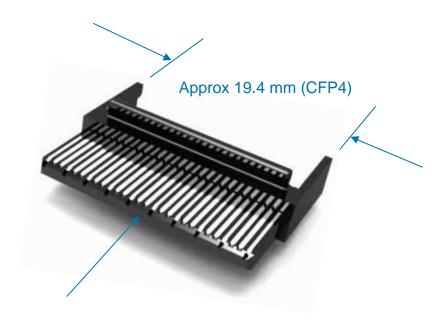






Quadra Connector (CFP4 Proposal), Plug





High Speed Contacts
Top side





Quadra Channel Simulation Set-Up

CONNECTOR

- QUADRA
- 2 piece connector design
- All 8 high speed pairs on top of the module board
- No vias required on module PCB



HOST BOARD

- Board material = N4000-13si
- Trace length = 4" and 7"
- Trace geometry = stripline
- Trace width = 5 mils
- Differential trace spacing = 6 mils
- PCB thickness = 0.093"
- 2 signal layers
- 6 ground planes
- Layer connection = layer 2 (near top)
- Counterbored [18mil stub]

PLUG BOARD

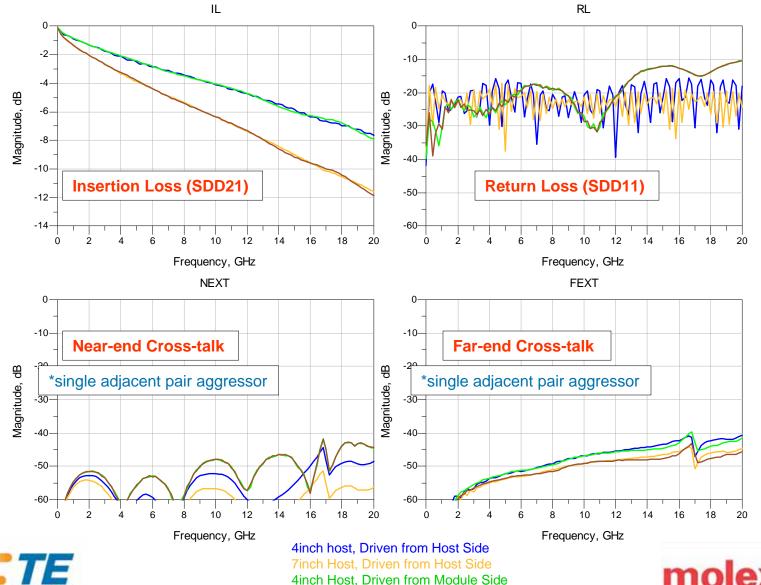
- Board Material = N4000-13si
- Trace length = 1.25"
- Trace geometry = mStrip
- Trace width = 7 mils
- Differential trace spacing = 5 mils



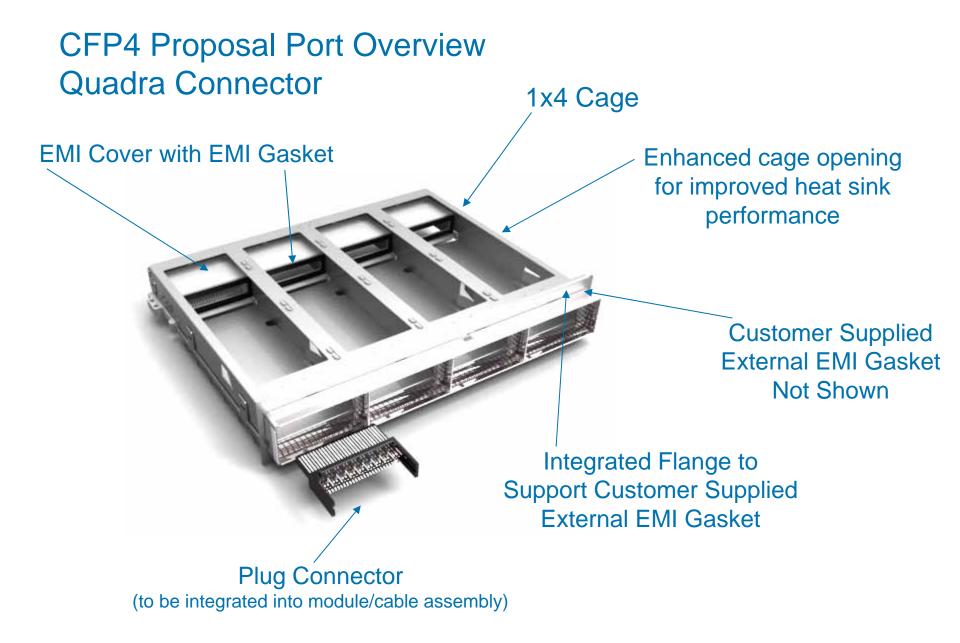


Quadra Channel (CFP2, CFP4), SI Modeling Results

Insertion/Return Loss/NEXT/FEXT

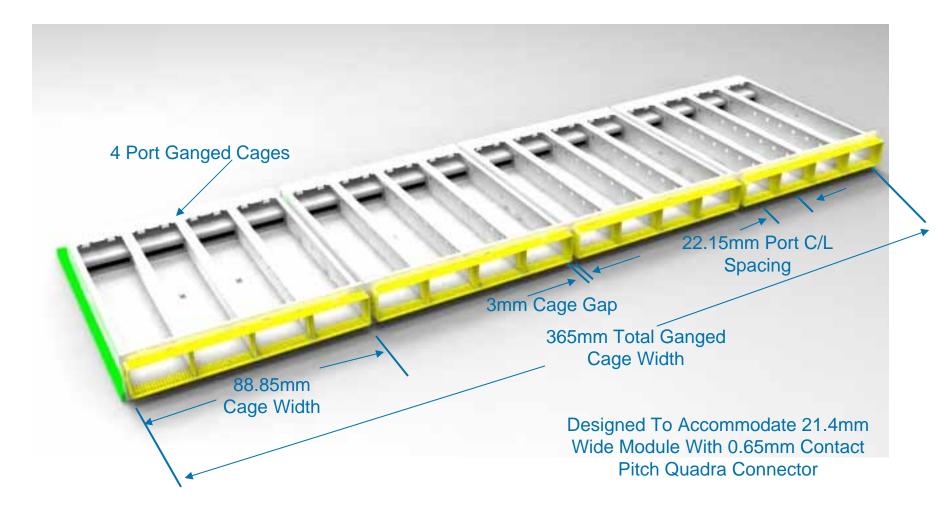


7inch Host, Driven from Module Side





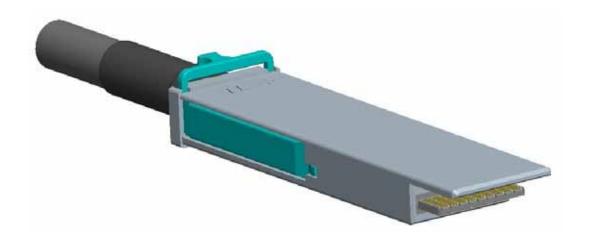
Quadra (CFP4 Proposal) Connector Mechanical Density 16 Port Line Card





CFP4 Proposal Copper Cable Assembly

- CFP4 port supports 100G CR4 copper direct attach cable assemblies
- Module form factor supports direct attach copper and modular solutions
- Optimized connector gives improved channel performance





Recommendation

- Similar to what was done with 802.3ba, we should support the demands of backwards compatibility and newer generations
 - -CFP MSA supports implementations of existing standards
- 802.3bj should recognize two MDIs that will be consistent with future implementations of 100G standards
 - -QSFP28
 - -CFP4

